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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Applicant: Kejun Zeng

Docket Number: TI-36531

Serial No.: 10/679,787

Art Unit: 1725

Filed: 10/06/03

Examiner: Jonathan J. Jonson

For: Connection Site Coating Method and Solder Joints

CERTIFICATION OF FACSIMILE TRANSMISSION

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<input type="checkbox"/> CONTINUATION APPN	<input type="checkbox"/> ELECTION
<input type="checkbox"/> DIVISIONAL APPN	
NAME OF INVENTOR(S):	
Kejun Zeng	
TITLE OF INVENTION: Connection Site Coating Method and Solder Joints	
TI FILE NO.:	DEPOSIT ACCT. NO.:
TI-36531	20-0668
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
PATENT APPLICATION

Appl. No. : 10/679,787 Confirmation No. 3730  
Applicant : Kejun Zeng  
Filed : October 6, 2003  
TC/A.U. : 1725  
Examiner : Johnson, Jonathan J  
Docket No. : TI-36531  
Customer No. : 23494

Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

CERTIFICATE OF MAILING OR TRANSMISSION UNDER 37  
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Date

Karen Vertz

Karen Vertz

AMENDMENT-B UNDER 37 C.F.R. 1.111

Dear Sir:

Responsive to the Office action dated October 14, 2005, applicant amends this application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 3 of this paper.